

## PATENT ASSIGNMENT COVER SHEET

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| <b>SUBMISSION TYPE:</b>   | NEW ASSIGNMENT                            |
| <b>NATURE OF CONVEYANCE:</b>  | ASSIGNMENT                                |
| <b>CONVEYING PARTY DATA</b>   |   |
| <b>Name</b>   | <b>Execution Date</b>                     |
| SHINJI YOSHIOKA   | 09/20/2016                                |
| HIROMICHI YAMASHITA   | 09/20/2016                                |
| AKIRA MAEKAWA   | 09/28/2016                                |
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| <b>State/Country:</b>   | JAPAN                                     |
| <b>PROPERTY NUMBERS Total: 1</b>  |   |
| <b>Property Type</b>  | <b>Number</b>                             |
| <b>Application Number:</b>  | 15312792                                  |
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| <b>SIGNATURE:</b>   | /Hiroko Lavietes/                         |
| <b>DATE SIGNED:</b>   | 11/21/2016                                |
| <b>Total Attachments: 1</b>   |   |
| source=Assignment#page1.tif   |   |

# ASSIGNMENT

( 譲 渡 証 )

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by HITACHI HIGH-TECHNOLOGIES CORPORATION, a corporation organized under the laws of Japan, located at 24-14, Nishi Shimbashi 1-chome, Minato-ku, Tokyo, Japan, receipt of which is hereby acknowledged I do hereby sell and assign to said HITACHI HIGH-TECHNOLOGIES CORPORATION, its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

## CHROMATOGRAPH MASS SPECTROMETER AND CONTROL METHOD THEREFOR

invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, No. PCT/IB2015/001277 filed 29/July/2015, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted, to be held and enjoyed by said HITACHI HIGH-TECHNOLOGIES CORPORATION, its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said HITACHI HIGH-TECHNOLOGIES CORPORATION,

Signed on the date(s) indicated aside our signatures:

INVENTOR(S)  
(発明者フルネームサイン)

Date Signed  
(署名日)

1) Shinji Yoshioka  
Shinji YOSHIOKA

9/20/2016

2) Hiromichi Yamashita  
Hiromichi YAMASHITA

9/20/2016

3) Akira Maekawa  
Akira MAEKAWA

9/28/2016